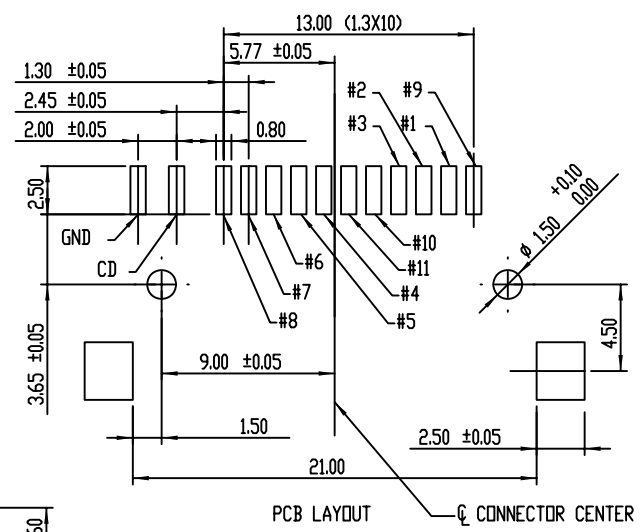
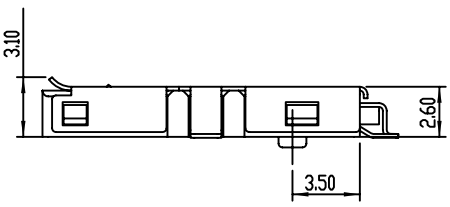


NOTES:
 1.MATERIAL:
 INSULATOR:HIGH TEMPRATURE THERMOPLASTIC,UL94V-0
 COLOR:BLACK
 CONTACT:PHOSPHOR BRONZE
 PLATING : CONTACT AREA :GOLD PLATED OVER Ni
 SOLDER AREA : Tin PLATED OVER Ni

PIN DEFINITION

MNSD#1	CD/DAT3
MNSD#2	CMD
MNSD#3	VSS1
MNSD#4	VDD
MNSD#5	CLK
MNSD#6	VSS2
MNSD#7	DAT0
MNSD#8	DAT1
MNSD#9	DAT2
MNSD#10	NC
MNSD#11	NC



109A-I X A 0-R01
 1 2 3 4

- 1.Type T:Top Mount
- 2.Contact Plating A:15u"Gold Plating B:3u" Gold Plating C:10u"Gold Plating D:Gold Flash
- 3.Stand Off A:0mm
- 4.RoHS

UNLESS OTHERWISE SPECIFIED TOLERANCE	
ANG.	±5
0.	±0.3
.0	±0.25
.00	±0.20
SCALE: AS SHOWN	UNIT: mm
DRAWN Willis	2008/7/21
CHECKED	/ /
APPROVED	/ /
DATE	SIZE A4

ATTEND TECHNOLOGY INC.
 www.attend.com.tw

DRAWN NAME:
 Mini SD Socket Top Mount Type

PRODUCT NO. 109A-TXA0-R01

FILE NAME: 109A-TXA0-R01

REV.	DESCRIPTION	DATE
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